

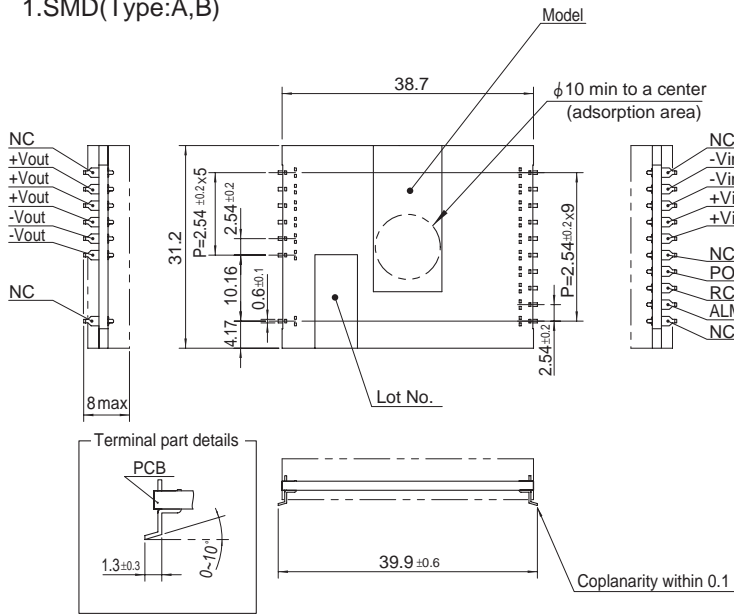
GENERAL SPECIFICATIONS

ISOLATION	INPUT-OUTPUT	DC1.500V 1minute, DC500V 50MΩ min (20±15°C)
ENVIRONMENT	OPERATING TEMP.,HUMID.AND ALTITUDE	-40 to +85°C, 20 - 95%RH (Non condensing), 3,000m (10,000feet) max
	STORAGE TEMP.,HUMID.AND ALTITUDE	-40 to +100°C, 20 - 95%RH (Non condensing), 9,000m (30,000feet) max
	VIBRATION	10 - 55Hz, 49.0m/s ² (5G), 3minutes period, 60minutes each along X, Y and Z axis
	IMPACT	196.1m/s ² (20G), 11ms, once each X, Y and Z axis
SAFETY	AGENCY APPROVALS	UL60950-1, C-UL (CSA60950-1), EN60950-1
OTHERS	CASE SIZE/WEIGHT	38.7×8.0×31.2mm (W×H×D) /20g max
	COOLING METHOD	Convection/Forced air

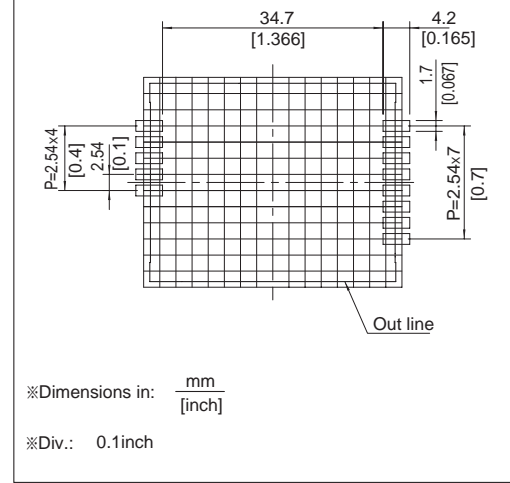
*1 At rated input(DC24V, DC48V), rated load and 25°C

External view

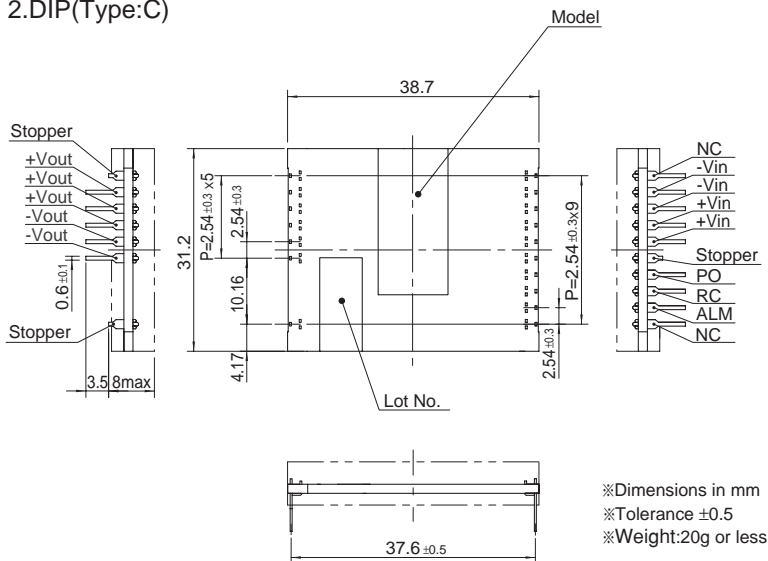
1.SMD(Type:A,B)



Recommended size for processing PCB (TOP VIEW)



2.DIP(Type:C)



Recommended size for processing PCB (TOP VIEW)

